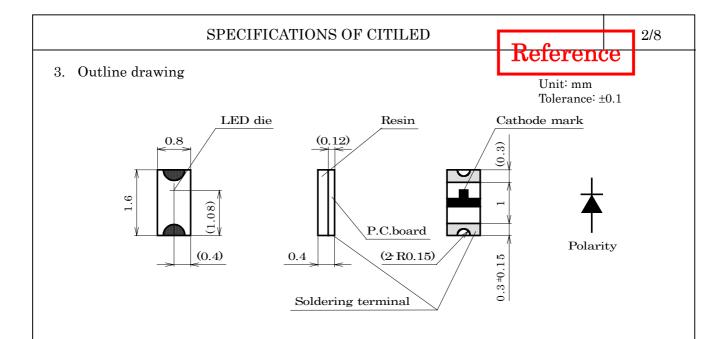
		SI	PECIFIC	ATIONS O	F CITILEI	)		1/8
		Application ecifications ap						erence
2.	Part cod	e						
				CL-1	<u>97</u> 1	ЧХ–	-C D-	T
	I C I	ighting color -	i small, th iigh brigh d : Bulk	tness lemon				
				Approved	Checked	Drawn	Symbol	CITILED
							Name	CL-197TLY
							Drawing No	
Mark	Date	Description	Appro.		CITIZI	EN ELECTR	ONICS CO.	LTD.



#### 4. Performance

#### (1) Absolute Maximum Rating

	0		(Ta=25°0
Parameter	Symbol	Rating Value	Unit
Power Dissipation	Pd	78	mW
Forward Current	IF	30	mA
Forward Pulse Current *	$_{ m IFP}$	100 *	mA
Reverse Voltage	$V_{\rm R}$	4	V
Operating Temperature	Top	$-25 \sim +80$	°C
Storage Temperature	$\operatorname{Tst}$	-30 ~ +85	°C

\* Duty  $\leq 1/10$ , Pulse width  $\leq 0.1$  msec

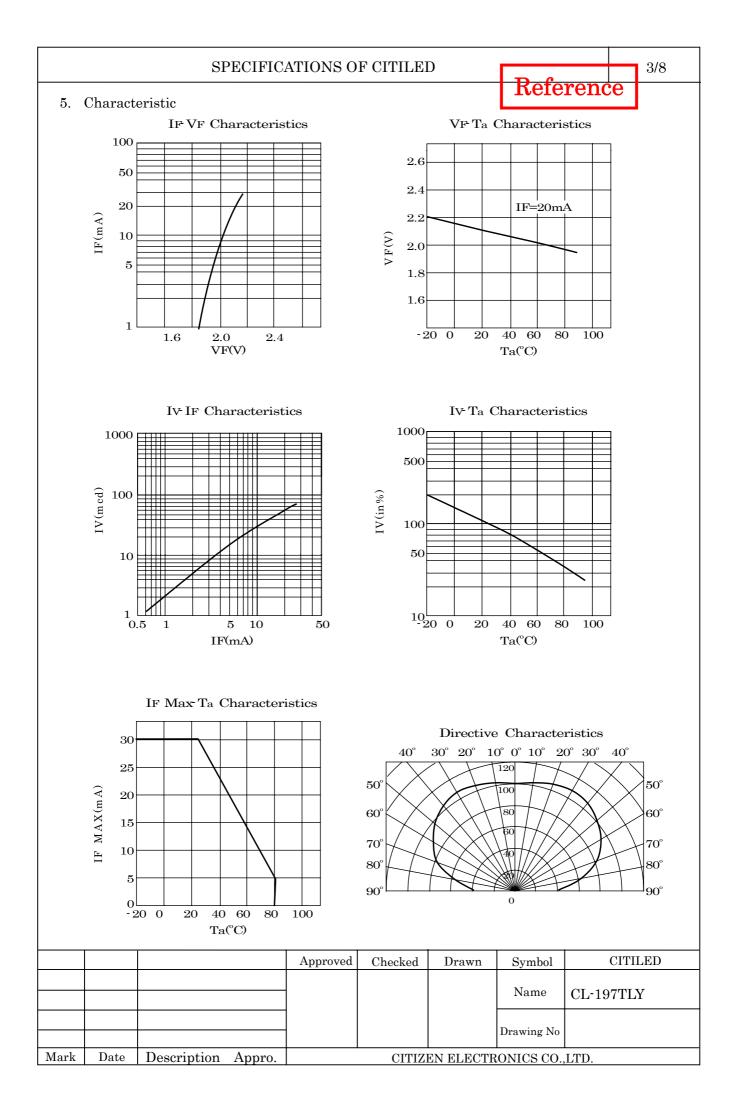
#### (2) Electro-optical Characteristic

 $(Ta=25^{\circ}C)$ 

						(1a - 20 0)
Parameter	Symbol	Condition	MIN	TYP	MAX	Unit
Forward Voltage	$V_{\rm F}$	IF=20mA	_	2.1	2.6	V
Reverse Current	IR	$V_R=4V$	_	—	100	μΑ
Luminous Intensity *	Iv	IF=20mA	16	60	_	mcd
Peak Wavelength	$\lambda_{ m P}$	IF=20mA	_	590	—	nm
Spectrum width of half value	Δλ	IF=20mA		13		nm

\* In accordance with NIST standard

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### SPECIFICATIONS OF CITILED

#### 6. Reliability

## Reference

(1) Details of the tests

Test Item	Test Condition					
Life Test in Continuous Operation	25±3°C, IF=30 mA $\times$ 500 $^{+24}_{-12}$ hours					
Low Temperature Storage Test	$-30^{+3}_{-5}$ °C × 500 $^{+24}_{-12}$ hours					
High Temperature Storage Test	85 $^{+5}_{-3}$ °C × 500 $^{+24}_{-12}$ hours					
Moisture-proof Test	$60 \pm 2^{\circ}$ C, $90 \pm 5\%$ RH for $500 \frac{+24}{-12}$ hours					
Thermal Shock Test	-30°C × 30 minutes - 85°C × 30 minutes, 5-cycle					
Solder Heat Resistance Test	Recommended temperature profile (reflow soldering) $\times$ 2, (2 <sup>nd</sup> test must be started after the samples are stabilized thermally.)					

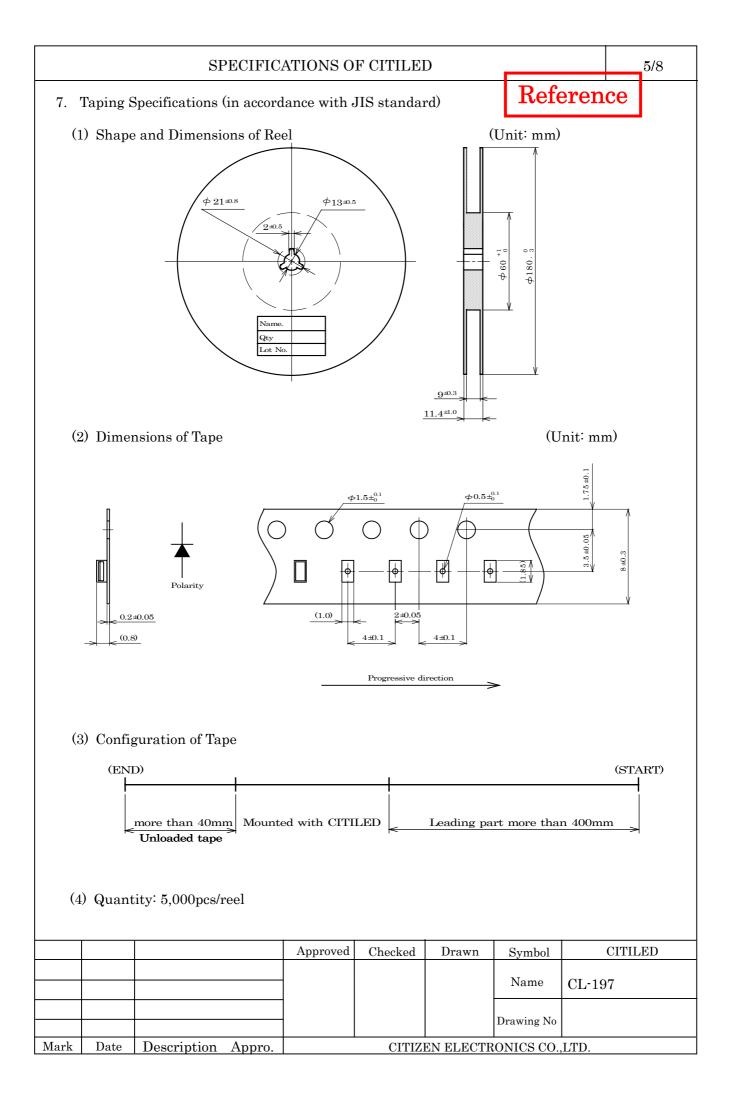
(2) Judgment Criteria of Failure for Reliability Test

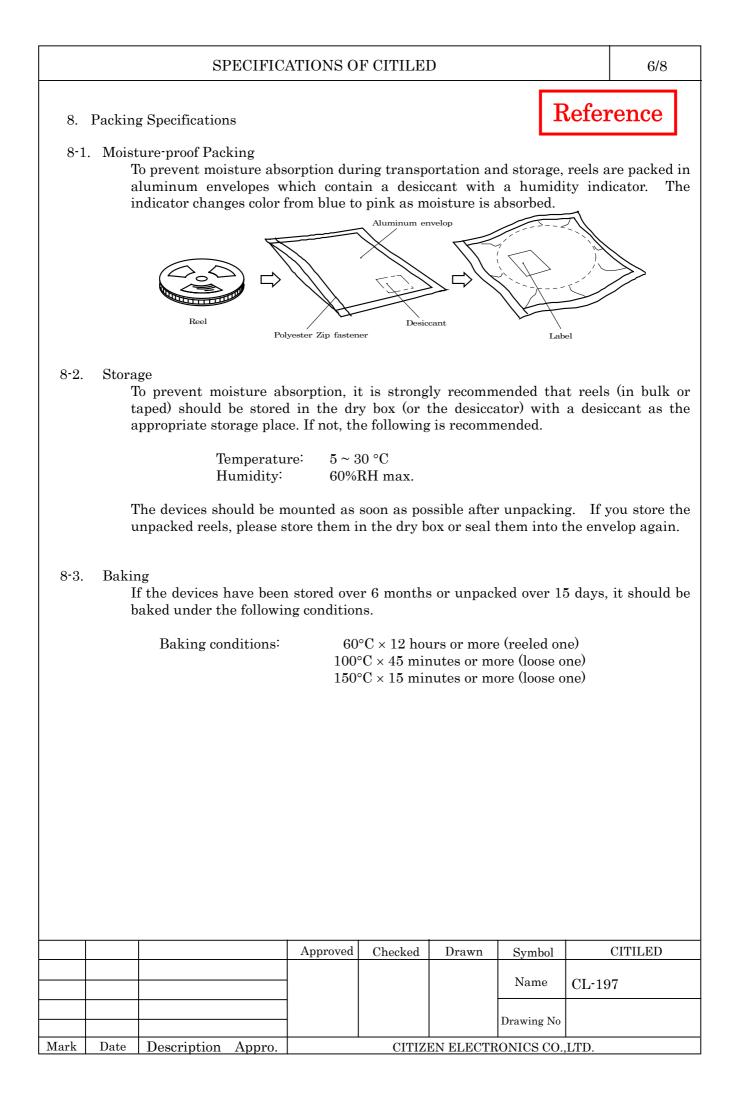
Measuring Item	Symbol	Measuring Condition	Judgement Criteria for Failure		
Forward Voltage	$V_{\mathrm{F}}$	I <sub>F</sub> = 20 mA	>U×1.2		
Reverse Current	$I_{R}$	$V_R=4$ V	>U×2		
Luminous Intensity	Iv	I <sub>F</sub> =20mA	<s×0.5< td=""></s×0.5<>		

U means the upper limit of the specified characteristics. S means the initial value.

Note: Measurement shall be taken between 2 hours and 24 hours, having returned the test pieces to the normal ambient conditions after the completion of each test.

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### SPECIFICATIONS OF CITILED

#### 9. Precautions

# Reference

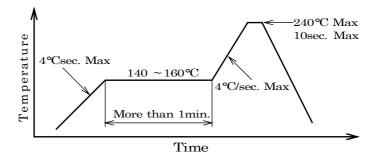
9-1. Soldering

#### (1) Manual soldering

- 1) Use 6/4 solder or solder containing silver (Ag)
  - If using Pb-free solder, solder of Sn 3.5Ag 0.75Cu is recommended.
- 2) Before soldering every time, make baking to units. By manual soldering, it is the possibility of crack due to the moisture absorption in the resin portion.
- 3) Use a soldering iron of 25W or smaller. Adjust the temperature of the soldering iron below 350°C.
- 4) Force or stress must not be applied to the resin portion while soldering.
- 5) Finish soldering within 3 seconds.
- 6) Handle the devices only after temperature is cooled down.

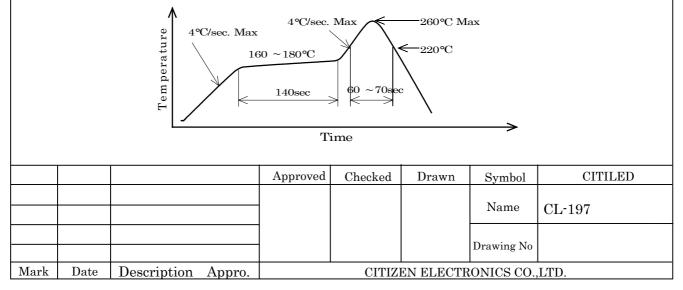
#### (2) Reflow soldering

- Following soldering paste is recommended Melting temperature: 178 ~ 192°C. Composition: Sn 63 %, Pb 37 %
- 2) The temperature profile at the top surface of the parts is recommended as shown below.
- 3) It is requested that products should be handled after their temperature has dropped down to the normal room temperature.



#### (3) Lead free soldering

- Following soldering paste is recommended Melting temperature: 216 ~ 220°C. Composition: Sn 3.5Ag 0.75Cu
- 2) The temperature profile at the top surface of the parts is recommended as shown below.
- 3) It is requested that products should be handled after their temperature has dropped down to the normal room temperature.



#### SPECIFICATIONS OF CITILED

## Reference

9-2. Washing

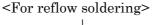
- (1) When washing after soldering is needed, following conditions are requested.
  - a) Washing solvent: Alcohol
  - b) Temperature, time:  $50^{\circ}$ C or less × 30 seconds max.
    - or 30°C or less × 3 minutes max.
  - c) Ultrasonic washing: 300W or less

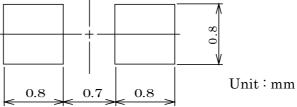
9-3. Other directions

- (1) It is requested to avoid any stress added to the resin portion while it is heated.
- (2) It is requested to avoid any friction by sharp metal nail etc. to the resin portion.

10.Designing precautions

- (1) The current limiting resistor should be placed in the circuit so that is driven within its rating. Also avoid reverse voltage (over-current) applied instantaneously when ON or OFF.
- (2) When pulse driving current is applied, average current consumption should be within the rating. Also avoid reverse voltage applied when put off.
- (3) Recommended soldering pattern

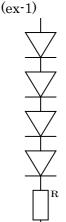


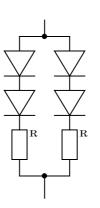


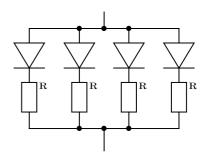
The above dimensions are not the one which guarantee the performance of mountability.

The use of the above pattern is recommended to use after deep study at your site.

- (4) When assembling the circuit board into the finished products, care must be taken to avoid the component parts from touching other parts.
- (5) When using multiple LEDs, it is required to connect a current limiting resistor on each path which the current flows to the LEDs.
  (ex-1) (ex-2) (ex-3)







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